



BROCADE 4

"Here is more rough

stuff on the ALTO

ALOHA network."

Memo sent by

400 GBE: THE NEXT ETHERNET TECHNOLOGY EVOLUTION

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RIPE 66

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Why 400 GbE? Why not TbE?

- Given that TbE is technically and economically impractical to develop until 2020+ we had to make a choice
 - Wait... for >10 years between Ethernet speed increases (100 GbE June 2010)
 - Start a feasible higher speed Ethernet standard now that can be ready by 2016 when the market needs something faster
- IEEE 802.3 Ethernet Bandwidth Assessment (BWA) Ad Hoc and the IEEE 802.3 Higher Speed Ethernet (HSE) Consensus Ad Hoc spent a lot of time analyzing market demand and technical options
- High degree of consensus in the IEEE that 400 GbE should be the next Ethernet speed
 - CFI straw poll: yes 132, no 0, abstain 1
 - Motion for Study Group: yes 87, no 0, abstain 4
- This will make the standardization process faster compared to 802.3ba
 - IEEE 802.3 Higher Speed Study Group first had to analyze market demand and technical options
 - Eventually decided on 40 GbE and 100 GbE



Theoretical M (1000) Form-factor Pluggable

Using Today's Technology is Impractical



- Using current technology 25 Gbps electrical signaling, a TbE module (MFP) would use 40 channels
- The size of the module can be estimated at $\frac{1}{2}$ sq. in. per W of power consumed
- If a CFP2 module consumes 12 W, then the MFP could consume 120 W
- This would require 60 sq. in. to cool and could make the module 6 in. by 10 in., taking up over 25% of the board space

IEEE 802.3 400 Gb/s Ethernet Study Group

- 400 GbE Call-For-Interest (CFI) was presented at the March, 2013 IEEE Plenary
- Approved to be an official IEEE Study Group on March 22, 2013
 - 400 GbE Study Group will define the objectives for reach and media
 - 400 GbE standard expected in 2016
- Study Group web page http://www.ieee802.org/3/400GSG/
- CDFP (CD (400) Form-factor Pluggable) Multi-Sourcing Agreement (MSA) announced to develop specifications for high-density 400 GbE modules
- First interfaces expected to be available in 2016+



400 GbE Module Evolution Estimates

Each Module Increases Density, While Reducing Cost and Power

	1 st Generation		2 nd Generation	3 rd Generation
Year	2016	2016	2019+	2022+
Electrical Signaling	CDAUI-16 16 x 25 Gbps	CDAUI-16 16 x 25 Gbps	CDAUI-8 8 x 50 Gbps	CDAUI-4 4 x 100 Gbps
Media Module	CDFP	CFP4(LR4) CFP4(LR4) CFP4(LR4) CFP4(LR4) 4 x CFP4	CDFP2	CDFP4

Images courtesy of TE Connectivity.



400 GbE CDFP Module Overview

- The CDFP MSA will define a specification for a module and the supporting hardware for a high-density 400 Gigabit Ethernet (400 GbE) based on 16 x 25 Gbps signaling
 - CD = 400 in Roman numerals, C = 100 and D = 500
 - FP = Form-factor Pluggable, follows the naming convention started in 1999 with the SFP Small Form-factor Pluggable
 - MSA = Multi-Sourcing Agreement, a legal document that defines a group that will define a specification for how to make and license the technology

Electrical Interface 16 x 25 Gbps in Each Direction

Image courtesy of the CDFP MSA. © 2013 Brocade Communications Systems, Inc.



Optical Interface With Two 16 Fiber Ribbons (16 Transmit Fibers + 16 Receiver Fibers)



CDFP Switch Overview

• The CDFP module will be defined to support several modules in a 1 RU (19") switch or modular switch blade to yield 4 Tbps of throughput



4 Tbps Slot Capacity vs. (4 x 100 GbE or 48 x 10 GbE)

More Information

- IEEE 802.3 Industry Connections Ethernet Bandwidth Assessment Ad Hoc
 http://www.ieee802.org/3/ad_hoc/bwa/index.html
- IEEE 802.3 Industry Connections Higher Speed Ethernet Consensus Ad Hoc http://www.ieee802.org/3/ad_hoc/hse/public/index.html
- IEEE 802.3 Higher Speed Study Group
 <u>http://www.ieee802.org/3/hssg/index.html</u>
- IEEE 400 GbE Call-For-Interest presentation

http://www.ieee802.org/3/cfi/0313_1/CFI_01_0313.pdf



QUESTIONS?



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